

To: Facsimile Number: 571-273-8300 CENTRAL FAX CENTER Total Pages Sent 15
From: Texas Instruments Incorporated
Facsimile: 972-917-4418

AUG 19 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Richard B. Irwin, et al. Docket Number: TI-36795
Serial No.: 10/814,673 Art Unit: 2826
Filed: 03/30/04 Examiner: Thomas Dickey
For: Dual Metal Schottky Diode

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office on the date shown below:

Karen Vert
Karen Vert

8-19-05
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT <u>116 (14 pages)</u>
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT _____
<input type="checkbox"/> DECLARATION	<input type="checkbox"/> NOTICE OF APPEAL _____
<input type="checkbox"/> ASSIGNMENT	<input type="checkbox"/> APPEAL <u>(# Pages)</u> _____
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE & PUBLICATION FEE <u>(1 Page)</u>
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPPLICATE) <u>(# Pages)</u>
<input type="checkbox"/> CONTINUATION APP'N	
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S):	
Richard B. Irwin, et al.	
TITLE OF INVENTION: Dual Metal Schottky Diode	
TI FILE NO.	DEPOSIT ACCT. NO.
<u>TI-36795</u>	<u>20-0668</u>
FAXED: 8-19-05	
DUE: 9-14-05	
ATTY/SECY: RAK/jv	
RECEIPT DATE & SERIAL NO.:	
Serial No.: 10/814,673	
Filing Date: 03/30/04	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 655474, MS 3999
Dallas, TX 75265-5474

RECEIVED
CENTRAL FAX CENTER

AUG 19 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Irwin et al. Docket No.: TI-36795
Serial No.: 10/814,673 Art Unit: 2826
Filed: 03/30/2004 Examiner: Dickey, Thomas
Title: Dual Metal Schottky Diode

**REPLY UNDER 37 C.F.R. §1.116 – EXPEDITED PROCEDURE
TECHNOLOGY CENTER 2800**

August 19, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Commissioner:

CERTIFICATION OF FACSIMILE TRANSMISSION
I hereby certify that the above correspondence is being
transmitted by facsimile to the U.S. Patent and Trademark Office
at 571.273.8300 on the date shown below.

Karen Vertz
Karen Vertz

8-19-05
Date

In response to the Office Action, dated 07/14/2005, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.